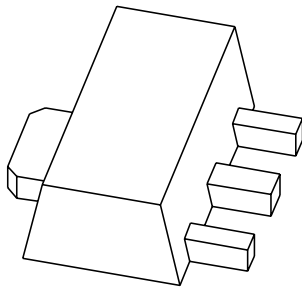


DATA SHEET



BST60; BST61; BST62 PNP Darlington transistors

Product specification
Supersedes data of 2001 Feb 20

2004 Dec 09

PNP Darlington transistors

BST60; BST61; BST62

FEATURES

- High current (max. 0.5 A)
- Low voltage (max. 80 V)
- Integrated diode and resistor.

APPLICATIONS

- Industrial switching applications such as:
 - Print hammer
 - Solenoid
 - Relay and lamp driving.

DESCRIPTION

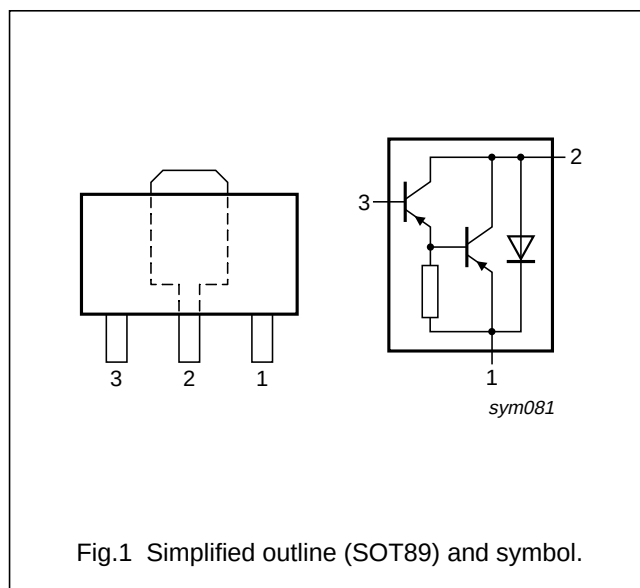
PNP Darlington transistor in a SOT89 plastic package.
NPN complements: BST50, BST51 and BST52.

MARKING

TYPE NUMBER	MARKING CODE
BST60	BS1
BST61	BS2
BST62	BS3

PINNING

PIN	DESCRIPTION
1	emitter
2	collector
3	base



ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
BST60	SC-62	plastic surface mounted package; collector pad for good heat transfer; 3 leads	SOT89
BST61			
BST62			

PNP Darlington transistors

BST60; BST61; BST62

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BST60		–	–60	V
	BST61		–	–80	V
	BST62		–	–90	V
V _{CES}	collector-emitter voltage	V _{BE} = 0 V			
	BST60		–	–45	V
	BST61		–	–60	V
	BST62		–	–80	V
V _{EBO}	emitter-base voltage	open collector	–	–5	V
I _C	collector current (DC)		–	–1	A
I _{CM}	peak collector current		–	–2	A
I _B	base current (DC)		–	–100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	–	1.3	W
T _{stg}	storage temperature		–65	+150	°C
T _j	junction temperature		–	150	°C
T _{amb}	ambient temperature		–65	+150	°C

Note

1. Device mounted on a printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 6 cm².
For other mounting conditions, see “*Thermal considerations for SOT89 in the General Part of associated Handbook*”.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	96	K/W
R _{th(j-s)}	thermal resistance from junction to soldering point		16	K/W

Note

1. Device mounted on a printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 6 cm².
For other mounting conditions, see “*Thermal considerations for SOT89 in the General Part of associated Handbook*”.

PNP Darlington transistors

BST60; BST61; BST62

CHARACTERISTICS

$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

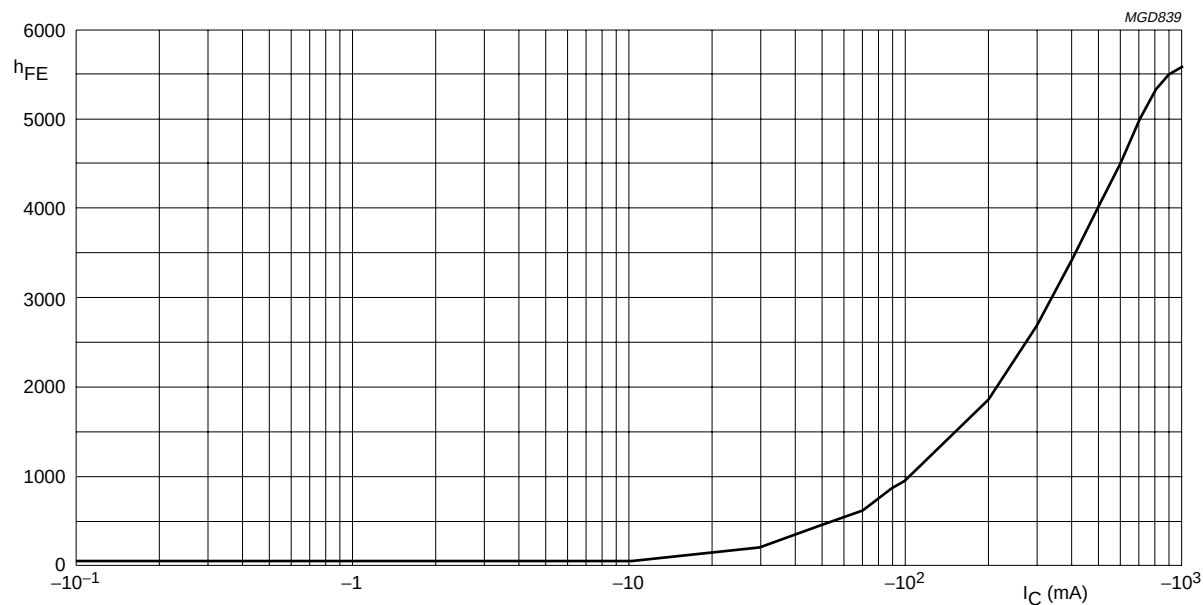
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CES}	collector-emitter cut-off current					
	BST60	$V_{BE} = 0\text{ V}; V_{CE} = -45\text{ V}$	–	–	–50	nA
	BST61	$V_{BE} = 0\text{ V}; V_{CE} = -60\text{ V}$	–	–	–50	nA
	BST62	$V_{BE} = 0\text{ V}; V_{CE} = -80\text{ V}$	–	–	–50	nA
I_{EBO}	emitter-base cut-off current	$I_C = 0\text{ A}; V_{EB} = -4\text{ V}$	–	–	–50	nA
h_{FE}	DC current gain	$V_{CE} = -10\text{ V}$; note 1; see Fig.2				
		$I_C = -150\text{ mA}$	1000	–	–	
		$I_C = -500\text{ mA}$	2000	–	–	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -500\text{ mA}; I_B = -0.5\text{ mA}$	–	–	–1.3	V
		$I_C = -500\text{ mA}; I_B = -0.5\text{ mA}; T_j = 150\text{ }^{\circ}\text{C}$	–	–	–1.3	V
V_{BEsat}	base-emitter saturation voltage	$I_C = -500\text{ mA}; I_B = -0.5\text{ mA}$	–	–	–1.9	V
f_T	transition frequency	$I_C = -500\text{ mA}; V_{CE} = -5\text{ V}; f = 100\text{ MHz}$	–	200	–	MHz
Switching times (between 10% and 90% levels); (see Fig.3)						
t_{on}	turn-on time	$I_{Con} = -500\text{ mA}; I_{Bon} = -0.5\text{ mA}; I_{Boff} = 0.5\text{ mA}$	–	500	–	ns
t_{off}	turn-off time		–	700	–	ns

Note

1. Pulse test: $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$.

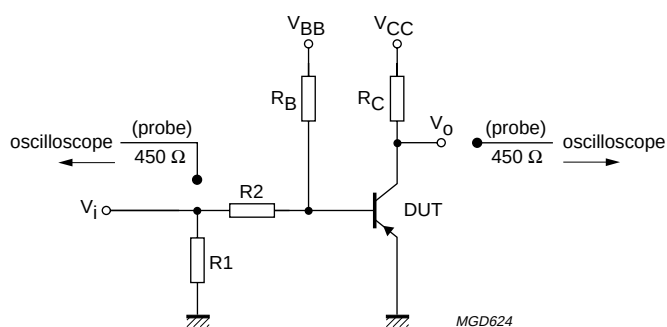
PNP Darlington transistors

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$V_{CE} = -10$ V.

Fig.2 DC current gain; typical values.



$V_i = -10$ V; $T = 200$ μ s; $t_p = 6$ μ s; $t_r = t_f \leq 3$ ns.
 $R_1 = 56$ Ω ; $R_2 = 10$ k Ω ; $R_B = 10$ k Ω ; $R_C = 18$ Ω .
 $V_{BB} = 1.8$ V; $V_{CC} = -10.7$ V.
 Oscilloscope: input impedance $Z_i = 50$ Ω .

Fig.3 Test circuit for switching times.

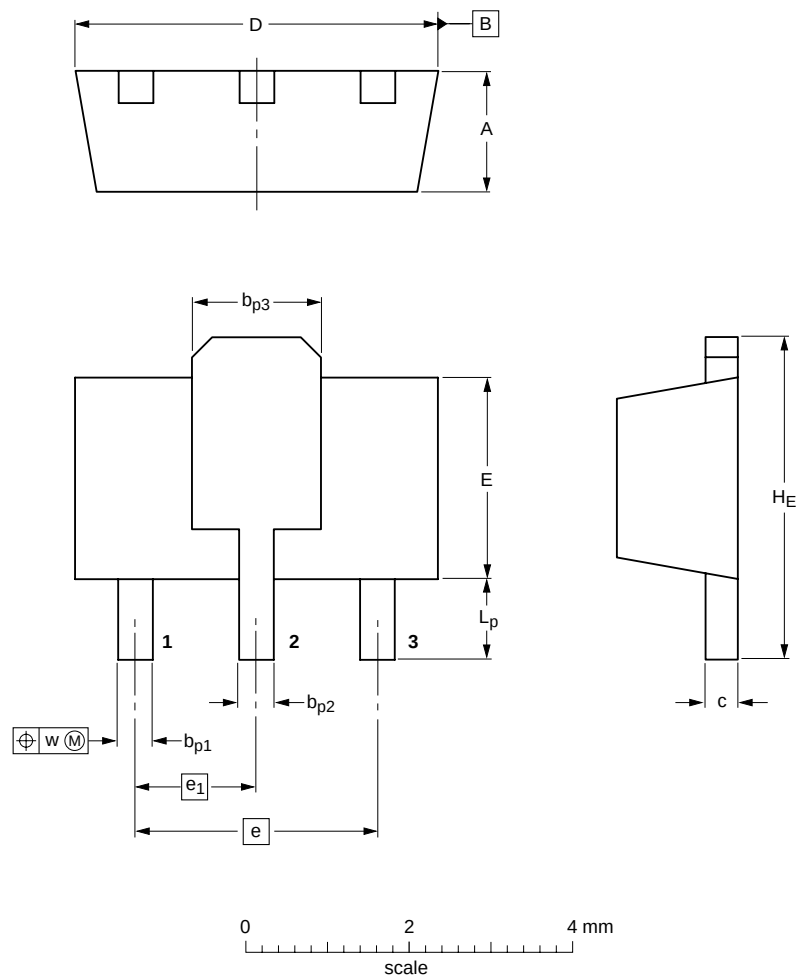
PNP Darlington transistors

BST60; BST61; BST62

PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 3 leads

SOT89



DIMENSIONS (mm are the original dimensions)

UNIT	A	bp1	bp2	bp3	c	D	E	e	e1	HE	Lp	w
mm	1.6 1.4	0.48 0.35	0.53 0.40	1.8 1.4	0.44 0.23	4.6 4.4	2.6 2.4	3.0	1.5	4.25 3.75	1.2 0.8	0.13

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT89		TO-243	SC-62			99-09-13 04-08-03

PNP Darlington transistors

BST60; BST61; BST62

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
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